



US00D381987S

# United States Patent [19] Tsuge

[11] Patent Number: **Des. 381,987**  
[45] Date of Patent: **\*\*Aug. 5, 1997**

## [54] HEADPHONE

[75] Inventor: **Takahiro Tsuge**, Tokyo, Japan  
[73] Assignee: **Sony Corporation**, Tokyo, Japan  
[\*\*] Term: **14 Years**

[21] Appl. No.: **48,951**  
[22] Filed: **Jan. 16, 1996**

[51] LOC (6) Cl. .... **14-01**  
[52] U.S. Cl. .... **D14/205**  
[58] Field of Search ..... D14/192, 205,  
D14/206, 223; 181/129, 130, 137; 379/430,  
431, 444; 381/25, 68, 158, 183, 187

## [56] References Cited

### U.S. PATENT DOCUMENTS

D. 254,183 2/1980 Doodson ..... D14/205  
D. 351,172 10/1994 Nakamura et al. .... D14/205  
D. 353,818 12/1994 Nakamura ..... D14/205  
D. 358,390 5/1995 Hayashi ..... D14/205

## FOREIGN PATENT DOCUMENTS

6054389 2/1994 Japan ..... 181/137

*Primary Examiner*—Sandra L. Morris  
*Assistant Examiner*—Nanda Bondade  
*Attorney, Agent, or Firm*—Cooper & Dunham LLP

## [57] CLAIM

The ornamental design for headphone, as shown and described.

## DESCRIPTION

FIG. 1 is a top plan view of a headphone showing my new design;

FIG. 2 is a right-side elevational view thereof;

FIG. 3 is a front elevational view thereof;

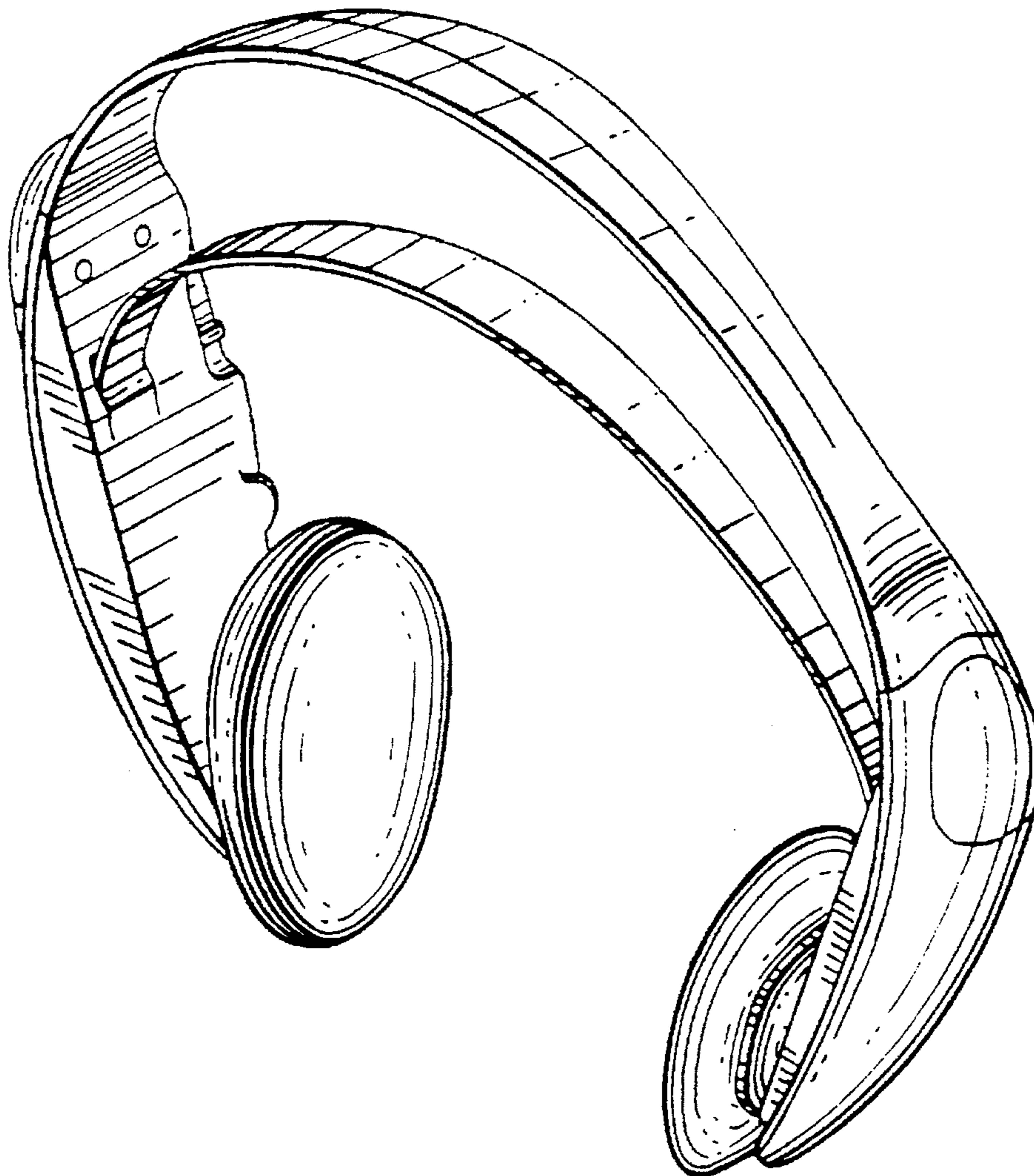
FIG. 4 is a left-side elevational view thereof;

FIG. 5 is a rear elevational view thereof;

FIG. 6 is a bottom plan view thereof; and,

FIG. 7 is a top, front and left-side perspective view thereof.

**1 Claim, 3 Drawing Sheets**



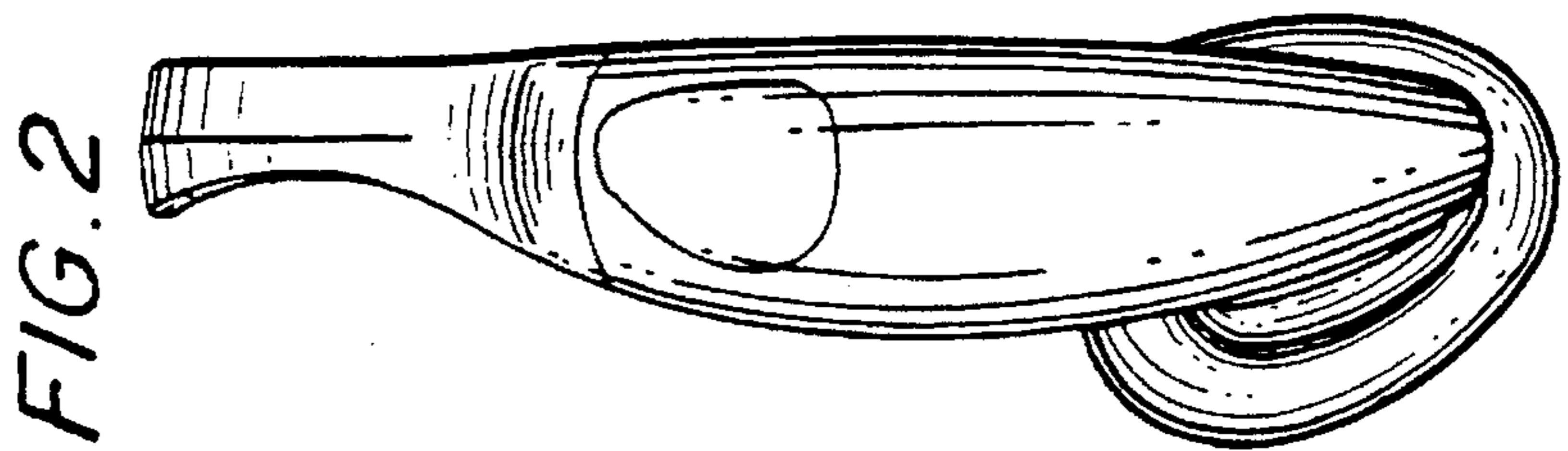
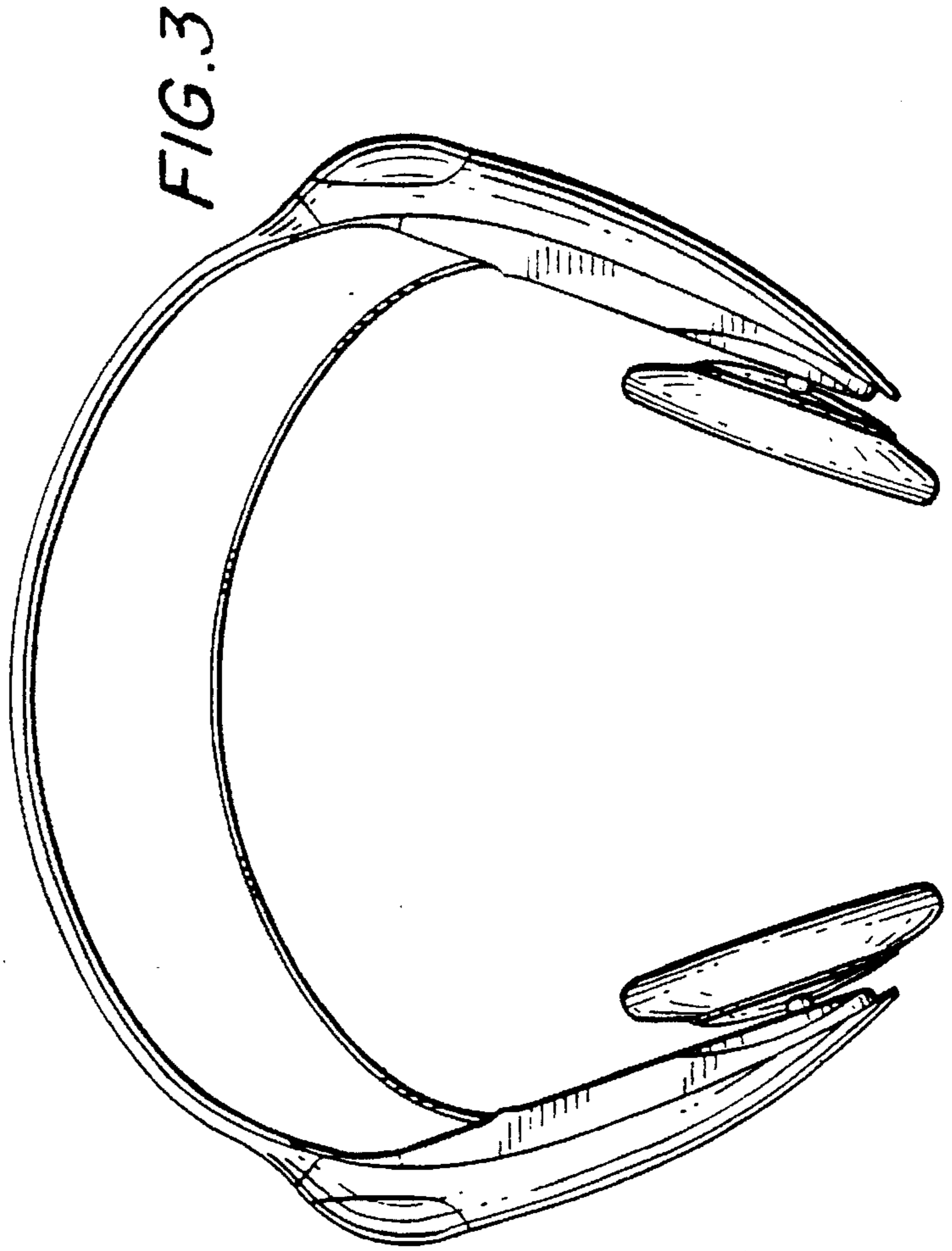
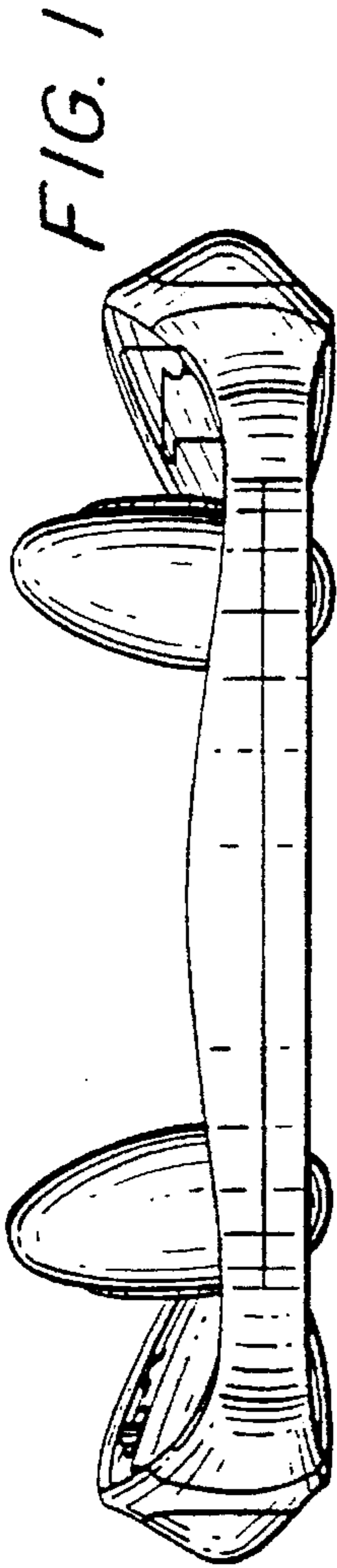


FIG. 4

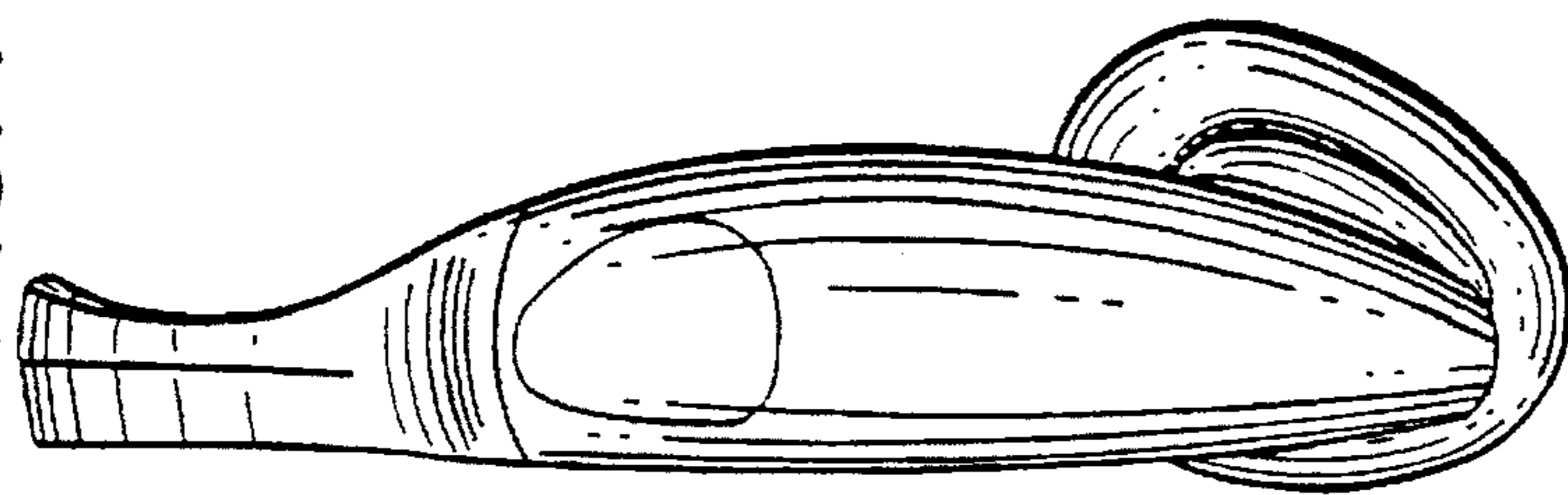


FIG. 5

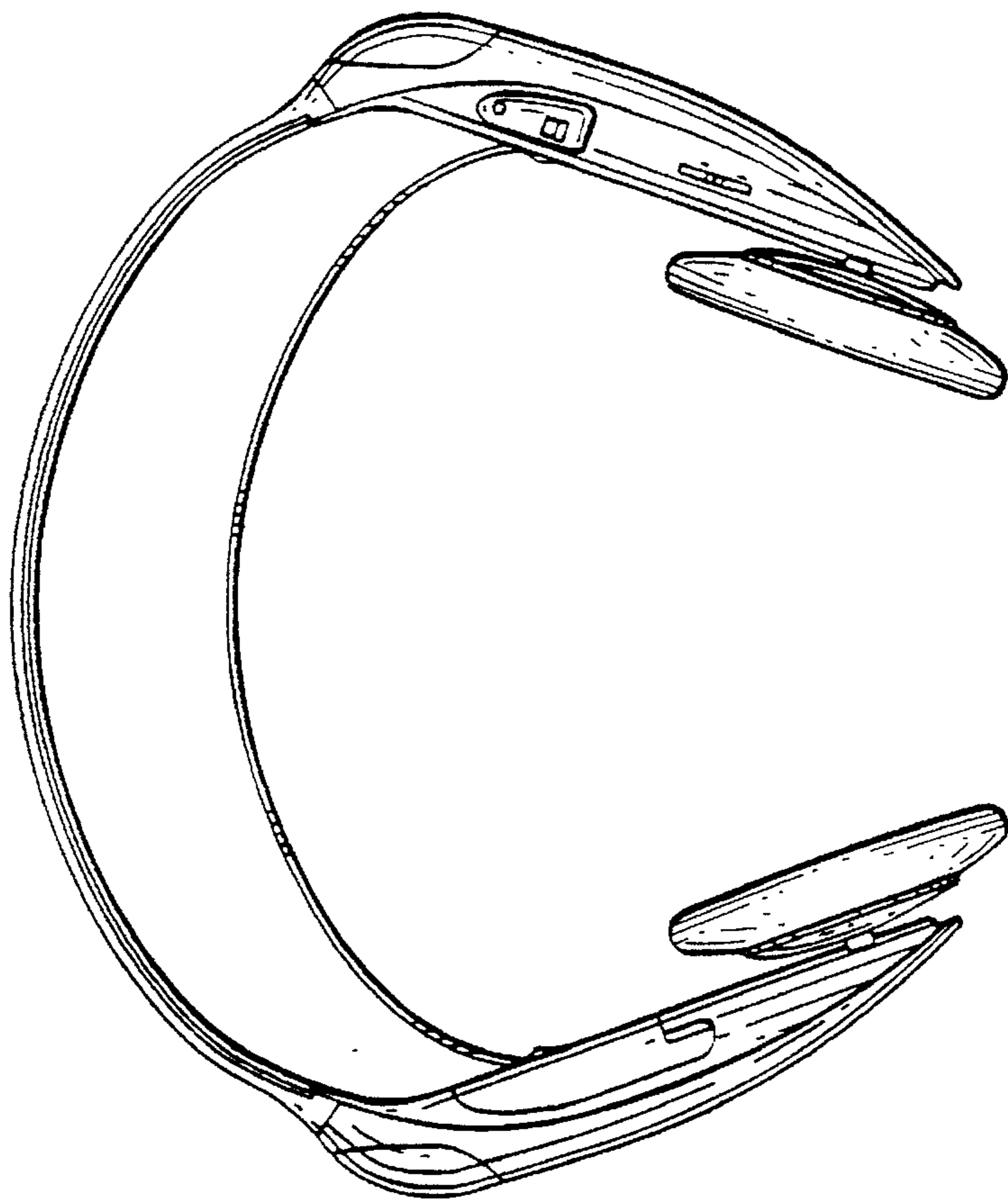


FIG. 6

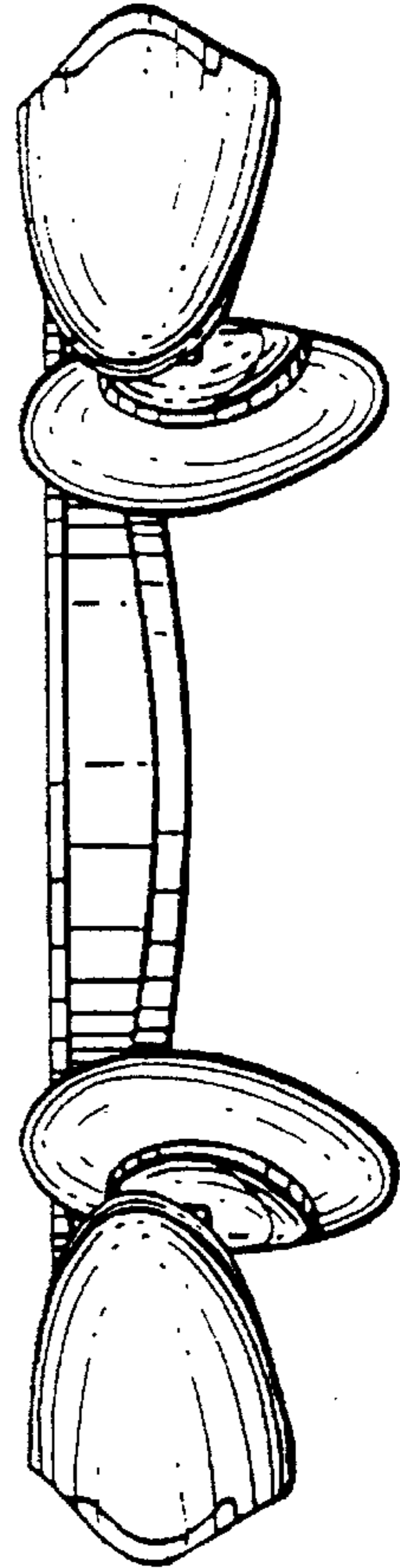


FIG. 7

